

Hermetic Infrared Emitting Diode

OP123, OP124, OP223, OP224

Electronics

Features:

- Hermetically sealed package
- Mechanically and spectrally matched to other OPTEK devices
- Designed for direct mount to PCBoard



Description:

Each **OP123** and **OP124** device is a 935 nanometer (nm) high intensity gallium arsenide infrared emitting diode (GaAs), mounted in a miniature hermetically sealed "pill" package with an enhanced temperature range and a high power output. These devices are designed for direct mounting to PCBoards.

Each **OP223** and **OP224** device is an 890 nm gallium aluminum arsenide infrared emitting diode (GaAlAs), mounted in a hermetically sealed "pill" package with an enhanced temperature range and a narrow irradiance pattern that provides high on-axis intensity for excellent coupling efficiency. These devices offer significantly higher power output than GaAs at equivalent drive currents and have a wavelength that is matched to silicon's peak response. Their small package size permits high device density mounting.

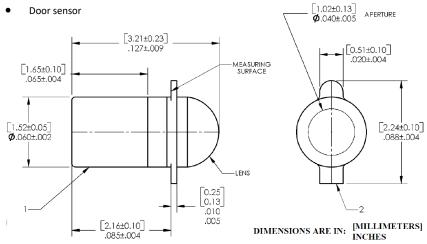
All these LEDs are mechanically and spectrally matched to the OP300 series, OP600 series and OP640 series devices.

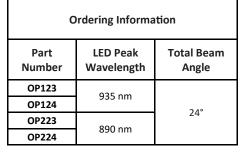
Please refer to Application Bulletins 208 and 210 for additional design information and reliability (degradation) data, and to

Application Bulletin 202 for pill-type soldering to PCBoard.

Applications:

- Non-contact reflective object sensor
- Assembly line automation
- Machine automation
- Machine safety
- End of travel sensor







Pin#	LED	Sensor		
1	Anode	Collector		
2	Cathode	Emitter		

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Hermetic Infrared Emitting Diode

OP123, OP124, OP223, OP224



Electrical Specifications

Absolute Maximum Ratings (T_A = 25° C unless otherwise noted)

Storage Temperature Range	-65° C to +150° C
Operating Temperature Range	-65° C to +125° C
Reverse Voltage	2.0 V
Continuous Forward Current	100 mA
Peak Forward Current (2 μs pulse with 0.1% duty cycle)	1.0 A
Lead Soldering Temperature [1/16 inch (1.6 mm) from case for 5 seconds with soldering iron]	260° C ⁽¹⁾⁽²⁾
Power Dissipation	100 mW ⁽¹⁾

Electrical Characteristics (T_A = 25° C unless otherwise noted)

SYMBOL	PARAMETER	MIN	TYP	MAX	UNITS	TEST CONDITIONS	
E _{E(APT)} ⁽³⁾	Apertured Radiant Incidence OP123 OP124 OP223 OP224	0.40 1.00 1.00 3.50	- - -		mW/cm²	I _F = 50 mA ⁽⁴⁾	
V _F	Forward Voltage OP123, OP124 OP223, OP224	-	-	1.50 1.80	V	I _F = 50 mA	
I _R	Reverse Current	-	-	100	μΑ	V _R = 2.0 V	
λ_{P}	Wavelength at Peak Emission OP123, OP124 OP223, OP224		935 890	-	nm	I _F = 50 mA I _F = 50 mA	
β	Spectral Bandwidth between Half Power Points OP123, OP124 OP223, OP224		50 80	-	nm	I _F = 50 mA I _F = 10 mA	
$\Delta\lambda_P/\Delta_T$	Spectral Shift with Temperature OP123, OP124 OP223, OP224		+0.30 +0.18	-	nm/° C	I _F = Constant	
ӨнР	Emission Angle at Half Power Points	-	24	-	Degree	I _F = 50 mA	
t _r	Output Rise Time OP123, OP124 OP223, OP224		1000 500	-	ns	I _{F(PK)} = 100 mA, PW = 10.0 μs,	
t _f	Output Fall Time OP123, OP124 OP223, OP224	-	500 250	-	ns	D.C. = 10.0%	

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^{1.} Refer to Application Bulletin 202 which reviews proper soldering techniques for pill-type devices.

^{2.} No clean or low solids. RMA flux is recommended. Duration can be extended to 10 seconds maximum when flow soldering.

3. Derate linearly 1.50 mW/° C above 25° C.

^{4.} For OP123, OP124, OP223 and OP224, E_{E(APT)} is a measurement using a 0.031" (0.787 mm) diameter apertured sensor placed 0.50" (12.7 mm) from the measuring surface. E_{E(APT)} is not necessarily uniform

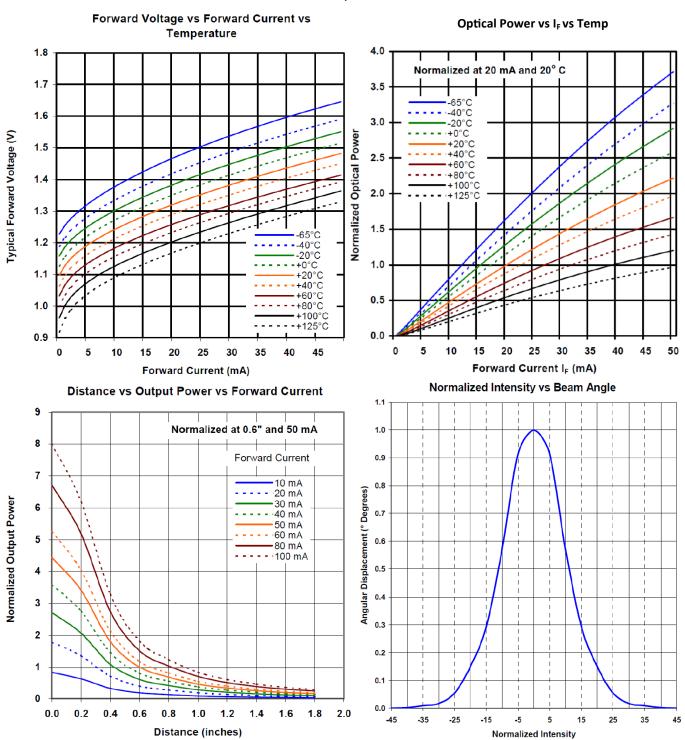


Hermetic Intrared Emitting Diode

OP123, OP124, OP223, OP224



Performance 0P123, 0P124





Hermetic Infrared Emitting Diode

OP123, OP124, OP223, OP224



Performance OP223, OP224

